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3	CLAIMS:				
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5	1. (Original) An energy conditioner comprising:				
6	an internally floating shield structure;				
7	a first electrode structure;				
8	a second electrode structure;				
9	wherein said first electrode structure comprises at least one first electrode structure				
10	first conductive layer, said second electrode structure comprises at least one second electrode				
11	structure first conductive layer;				
12	wherein said internally floating shield structure shields said first electrode structure				
13	first conductive layer from said second electrode structure, and said internally floating shield				
14	structure shields said second electrode structure first conductive layer from said first electrode				
15	structure; and				
16	said first electrode structure includes a first electrode contact region.				
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18	2. (Original) A filter arrangement comprising the energy conditioner of claim 1 and				
19	a conductive line segment of a circuit, wherein said first electrode structure contact region is				
20	electrically connected to said conductive line segment.				
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22	3. (Original) A capacitively/inductively coupling energy conditioner, comprising:				
23	an internally floating shield structure;				
24	a first electrode structure;				
25	a second electrode structure;				
26	wherein said first electrode structure comprises at least one first electrode structure				
27	first conductive layer, said second electrode structure comprises at least one second electrode				
28	structure first conductive layer;				
29	wherein said internally floating shield structure shields said first electrode structure				
30	first conductive layer from said second electrode structure, and said internally floating shield				

structure shields said second electrode structure first conductive layer from said first electrode 1 2 structure; and said first electrode structure includes a first electrode capacitive/inductive coupling 3 4 pad. 5 A filter arrangement comprising the capacitively/inductively coupling 6 4. (Original) energy conditioner of claim 3 and a conductive line segment of a circuit, wherein first 7 electrode capacitive/inductive coupling pad is capacitively/inductively coupled to said 8 9 conductive line segment. 10 An internally shielded capacitor comprising; 5. 11 (Original) a shielding conductive layer; 12 a first electrode defining at least a first electrode layer, wherein said first electrode 13 layer is above said shielding conductive layer; 14 a second electrode defining at least a second electrode layer, wherein said second 15 16 electrode layer is below said shielding conductive layer; wherein said shielding, said first electrode, and said second electrode are electrically 17 18 isolated from one another; and wherein said first electrode, said second electrode, and said shielding conductive layer 19 are positioned and sized relative to one another such that any straight line passing through 20 said first electrode and said second electrode contacts said shielding conductive layer. 21 22 An energy conditioner comprising; 23 б. (Original) a shielding defining at least (1) upper shielding conductive layer, (2) a center shielding 24 conductive layer, and (3) a lower shielding conductive layer, wherein said upper shielding 25 conductive layer is above said center shielding conductive layer and said center shielding 26 27 conductive layer is above said lower shielding conductive layer; a first electrode defining at least a first electrode layer, wherein said first electrode 28 layer is below said upper shielding conductive layer and above said center shielding 29 30 conductive layer;

1	a second electrode defining at least a second electrode layer, wherein said second				
2	electrode layer is below said center shielding conductive layer and above said lower shielding				
3	conductive layer; and				
4	wherein said shielding, said first electrode, and said second electrode are electrically				
5	isolated from one another; and				
6	wherein said first electrode, said second electrode, and said center shielding				
7	conductive layer are positioned and sized relative to one another such that any straight line				
8	passing through said first electrode and said second electrode contacts said center shielding				
9	conductive layer.				
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11	7. (Original) The conditioner of claim 6, wherein said shielding further comprises at				
12	least one conductive aperture operable for conductively coupling together all of said shielding				
13	conductive layers to one another.				
14					
15	8. (Original) The conditioner of claim 6, wherein said shielding further comprises at				
16	least one conductive via structure operable for conductively coupling together all of said				
17	shielding conductive layers to one another.				
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19	9. (Original) The conditioner of claim 6, wherein said shielding further comprises at				
20	least one conductive aperture, wherein said at least one conductive aperture passes through at				
21	least said first electrode layer or said second electrode layer; and				
22	wherein said at least one conductive aperture is operable for conductively coupling				
23	together all of said shielding conductive layers to one another.				
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25	10. (Original) The conditioner of claim 6, wherein said shielding further comprises at				
26	least one conductive via structure, wherein said at least one conductive via structure passes				
27	through at least said first electrode layer or said second electrode layer; and				
28	wherein said at least one conductive via structure is operable for conductively				
29	coupling together all of said shielding conductive layers to one another.				

The energy conditioner of claim 7, wherein said shielding is not 1 11. (Original) operable to be physically coupled to a circuit path. 2 3 The energy conditioner of claim 8, wherein said shielding is not 4 12. (Original) operable to be physically coupled to a circuit path. 5 6 A method of making an energy conditioner comprising: 7 13. (Original) 8 providing an internally floating shield structure; providing a first electrode structure; 9 providing a second electrode structure; 10 wherein said first electrode structure comprises at least one first electrode structure 11 first conductive layer, said second electrode structure comprises at least one second electrode 12 13 structure first conductive layer; wherein said internally floating shield structure shields said first electrode structure 14 first conductive layer from said second electrode structure, and said internally floating shield 15 structure shields said second electrode structure first conductive layer from said first electrode 16 17 structure; and said first electrode structure includes a first electrode contact region. 18 19 A method of making filter arrangement comprising (1) an energy 20 14. (Original) conditioner comprising an internally floating shield structure; a first electrode structure; a 21 second electrode structure; wherein said first electrode structure comprises at least one first 22 electrode structure first conductive layer, said second electrode structure comprises at least 23 one second electrode structure first conductive layer; wherein said internally floating shield 24 structure shields said first electrode structure first conductive layer from said second electrode 25 structure, and said internally floating shield structure shields said second electrode structure 26 first conductive layer from said first electrode structure; wherein said first electrode structure 27 includes a first electrode contact region and (2) a conductive line segment of a circuit, 28 wherein said first electrode structure contact region is electrically connected to said 29

conductive line segment, comprising the steps of:

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1	providing said energy conditioner;				
2	providing said conductive line segment; and				
3	electrically connecting said conductive line segment to said energy conditioner.				
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5	15.	(Original)	A method of making a capacitively/inductively coupling energy		
6	conditioner, comprising:				
7	providing an internally floating shield structure;				
8	providing a first electrode structure;				
9	providing a second electrode structure;				
10	wherein said first electrode structure comprises at least one first electrode structure				
11	first conductive layer, said second electrode structure comprises at least one second electrode				
12	structure first conductive layer;				
13	wherein said internally floating shield structure shields said first electrode structure				
14	first conductive layer from said second electrode structure, and said internally floating shield				
15	structure shields said second electrode structure first conductive layer from said first electrode				
16	structure; and				
17	said first electrode structure includes a first electrode capacitive/inductive coupling				
18	pad.				
19					
20	16.	(Original)	The method of making a circuit including the method of claim 15, and		
21	further comprising capacitively/inductively coupling said energy conditioner to a conductive				
22	line segment.				
23					
24	17.	(Original)	A method of making an internally shielded capacitor comprising;		
25		providing a s	hielding conductive layer;		
26		providing a f	irst electrode defining at least a first electrode layer, wherein said first		
27	electrode layer is above said shielding conductive layer;				
28	providing a second electrode defining at least a second electrode layer, wherein said				
29	second electrode layer is below said shielding conductive layer;				
30	wherein said shielding, said first electrode, and said second electrode are electrically				

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isolated from one another; and wherein said first electrode, said second electrode, and said shielding conductive layer are positioned and sized relative to one another such that any straight line passing through said first electrode and said second electrode contacts said shielding conductive layer. A method of making an energy conditioner comprising; 18. (Original) providing a shielding defining at least (1) upper shielding conductive layer, (2) a center shielding conductive layer, and (3) a lower shielding conductive layer, wherein said upper shielding conductive layer is above said center shielding conductive layer and said center shielding conductive layer is above said lower shielding conductive layer; providing a first electrode defining at least a first electrode layer, wherein said first electrode layer is below said upper shielding conductive layer and above said center shielding conductive layer; providing a second electrode defining at least a second electrode layer, wherein said second electrode layer is below said center shielding conductive layer and above said lower shielding conductive layer; and wherein said shielding, said first electrode, and said second electrode are electrically isolated from one another; and wherein said first electrode, said second electrode, and said center shielding conductive layer are positioned and sized relative to one another such that any straight line passing through said first electrode and said second electrode contacts said center shielding conductive layer. The method of claim 18, wherein said shielding further comprises at 19. (Original) least one conductive aperture operable for conductively coupling together all of said shielding conductive layers to one another. The method of claim 18, wherein said shielding further comprises at 20. (Original) least one conductive via structure operable for conductively coupling together all of said shielding conductive layers to one another.

The method claim 18, wherein said shielding further comprises at least 21. 1 (Original) one conductive aperture, wherein said at least one conductive aperture passes through at least 2 said first electrode layer or said second electrode layer; and 3 wherein said at least one conductive aperture is operable for conductively coupling 4 5 together all of said shielding conductive layers to one another. 6 22. The method of claim 18, wherein said shielding further comprises at 7 (Original) least one conductive via structure, wherein said at least one conductive via structure passes 8 through at least said first electrode layer or said second electrode layer; and 9 wherein said at least one conductive via structure is operable for conductively 10 coupling together all of said shielding conductive layers to one another. 11 12 The method of claim 19, wherein said shielding is designed to be 13 23. (Original) 14 physically isolated from a circuit path. 15 16 24. (Original) The energy conditioner of claim 20, wherein said shielding is designed 17 be physically isolated from a circuit path. 18 19 25. (Original) A method of using an energy conditioner, said energy conditioner 20 comprising: an internally floating shield structure; a first electrode structure; a second electrode 21 22 structure; wherein said first electrode structure comprises at least one first electrode structure first conductive layer, said second electrode structure comprises at least one second electrode 23 structure first conductive layer; wherein said internally floating shield structure shields said 24 first electrode structure first conductive layer from said second electrode structure, and said 25 internally floating shield structure shields said second electrode structure first conductive 26 layer from said first electrode structure; and said first electrode structure includes a first 27 28 electrode contact region, said method comprising: connecting said energy conditioner in an electrical circuit. 29 30

26. (Original) A method of using a capacitively/inductively coupling energy conditioner, said energy conditioner comprising: an internally floating shield structure; a first electrode structure; a second electrode structure; wherein said first electrode structure comprises at least one first electrode structure first conductive layer, said second electrode structure comprises at least one second electrode structure first conductive layer; wherein said internally floating shield structure shields said first electrode structure first conductive layer from said second electrode structure, and said internally floating shield structure shields said second electrode structure first conductive layer from said first electrode structure; and said first electrode structure includes a first electrode capacitive/inductive coupling pad, said method comprising:

connecting said energy conditioner in an electrical circuit.

27. (Original) A method of using an internally shielded capacitor, said internally shielded capacitor comprising: a shielding conductive layer; a first electrode defining at least a first electrode layer, wherein said first electrode layer is above said shielding conductive layer; a second electrode defining at least a second electrode layer, wherein said second electrode layer is below said shielding conductive layer; wherein said shielding, said first electrode, and said second electrode are electrically isolated from one another; and wherein said first electrode, said second electrode, and said shielding conductive layer are positioned and sized relative to one another such that any straight line passing through said first electrode and said second electrode contacts said shielding conductive layer, said method comprising:

connecting said internally shielded capacitor in an electrical circuit.

28. (Original) A method of using an energy conditioner, said energy conditioner comprising: a shielding defining at least (1) upper shielding conductive layer, (2) a center shielding conductive layer, and (3) a lower shielding conductive layer, wherein said upper shielding conductive layer is above said center shielding conductive layer and said center shielding conductive layer is above said lower shielding conductive layer; a first electrode defining at least a first electrode layer, wherein said first electrode layer is below said upper

shielding conductive layer and above said center shielding conductive layer; a second

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2 electrode defining at least a second electrode layer, wherein said second electrode layer is below said center shielding conductive layer and above said lower shielding conductive layer; 3 4 and wherein said shielding, said first electrode, and said second electrode are electrically isolated from one another; and wherein said first electrode, said second electrode, and said 5 6 center shielding conductive layer are positioned and sized relative to one another such that 7 any straight line passing through said first electrode and said second electrode contacts said 8 center shielding conductive layer, said method comprising: 9 connecting said energy conditioner in an electrical circuit. 10 11 29. (Original) The method of claim 28, wherein said shielding further comprises at 12 least one conductive aperture operable for conductively coupling together all of said shielding 13 conductive layers to one another. 14 15 30. (Original) The method of claim 28, wherein said shielding further comprises at 16 least one conductive via structure operable for conductively coupling together all of said 17 shielding conductive layers to one another. 18 19 31. (Original) The method of claim 28, wherein said shielding further comprises at 20 least one conductive aperture, wherein said at least one conductive aperture passes through at 21 least said first electrode layer or said second electrode layer; and 22 wherein said at least one conductive aperture is operable for conductively coupling 23 together all of said shielding conductive layers to one another. 24 25 32. (Original) The method of claim 28, wherein said shielding further comprises at 26 least one conductive via structure, wherein said at least one conductive via structure passes 27 through at least said first electrode layer or said second electrode layer; and 28 wherein said at least one conductive via structure is operable for conductively 29 coupling together all of said shielding conductive layers to one another.

1 33. (Original) The method of claim 29, wherein said shielding is designed to be physically isolated from a circuit path.

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4 34. (Original) The method of claim 30, wherein said shielding is designed to be

5 physically isolated from a circuit path.

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